

MCU_RF_Board_WBA2_QFN48

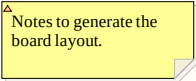
MB2293

Table of contents

- Sheet 1: Project overview (this page)
- Sheet 2: Top
- Sheet 3: MCU I/Os
- Sheet 4: RF & Power management
- Sheet 5 : QuadSPI

Legend

- General comment such as function title, configuration, ...
- Text to be added to silkscreen.
- Warning text.



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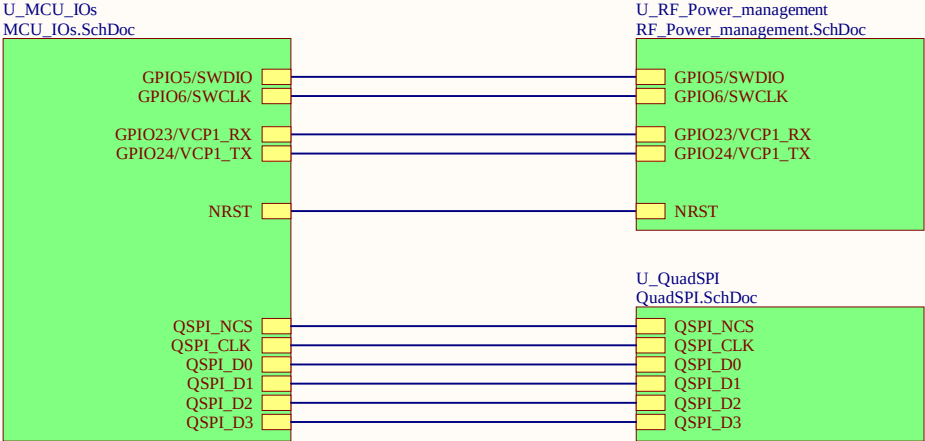
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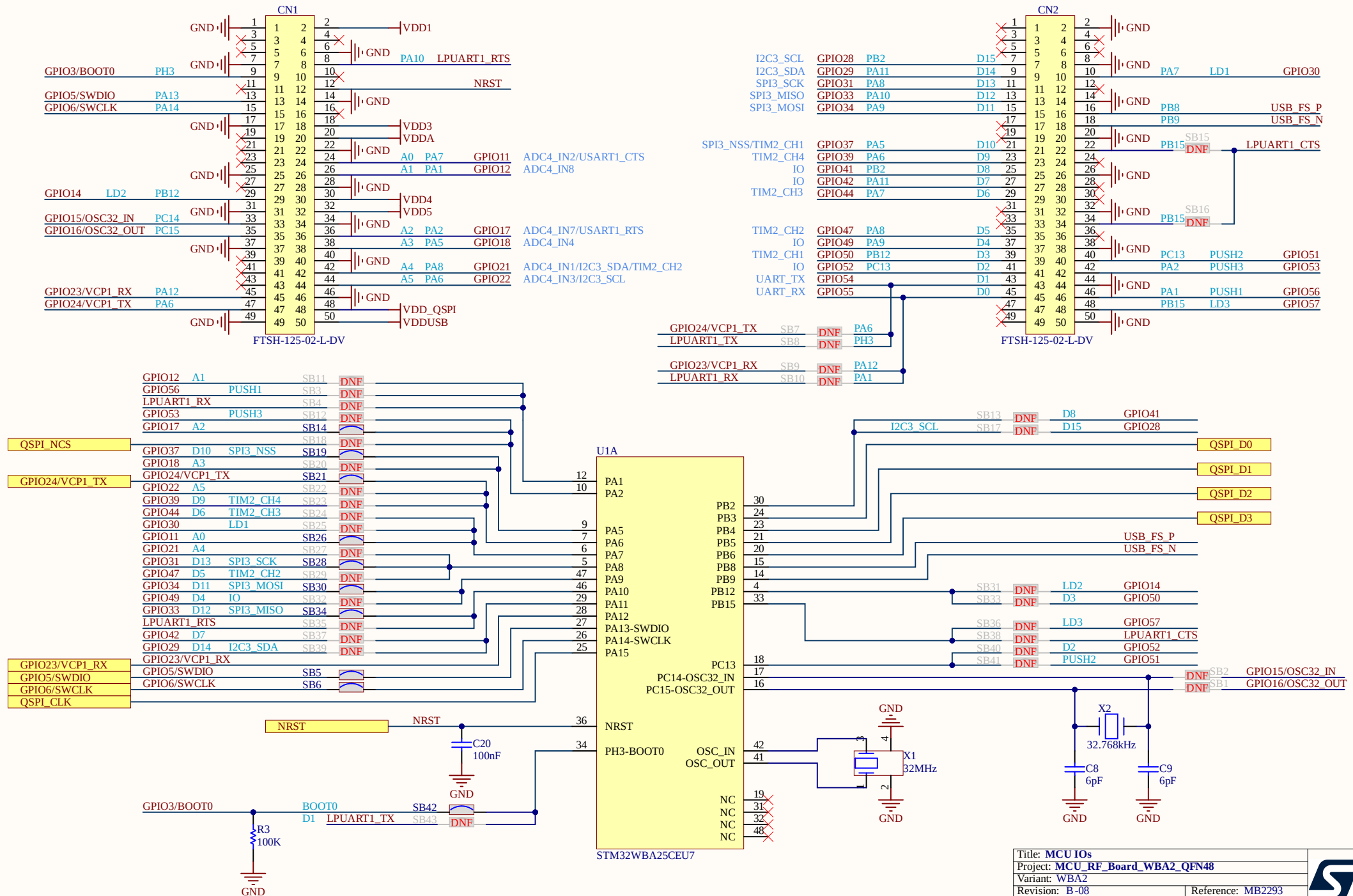
U_Top
Top.SchDoc

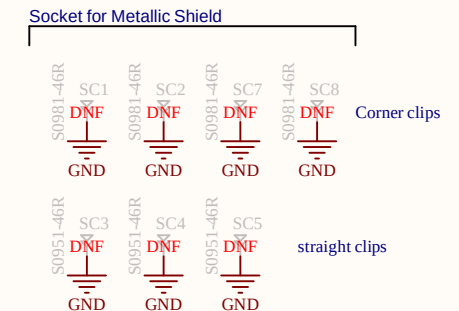
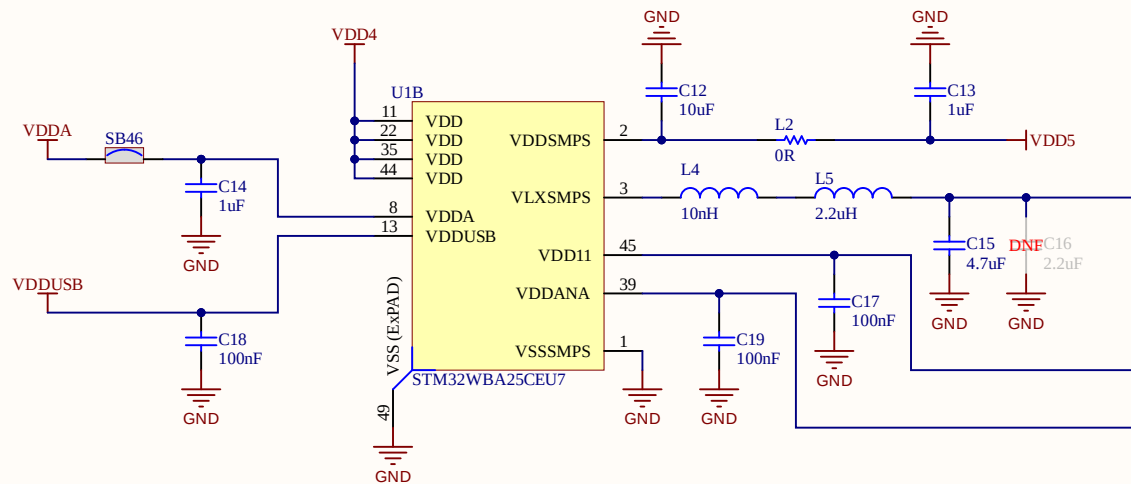
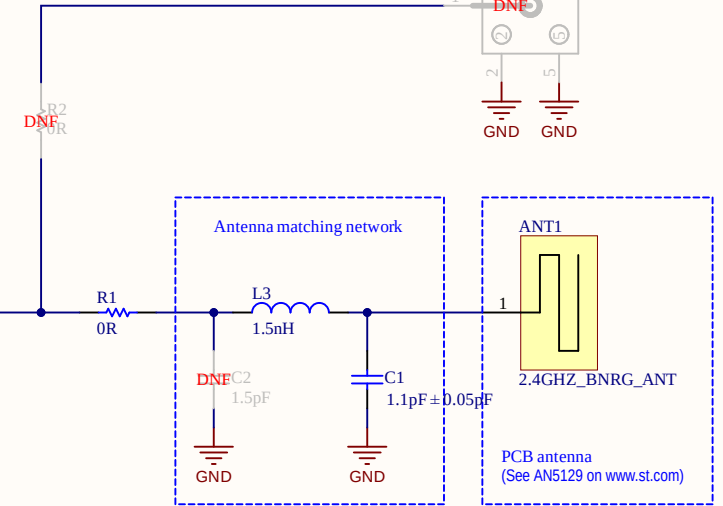
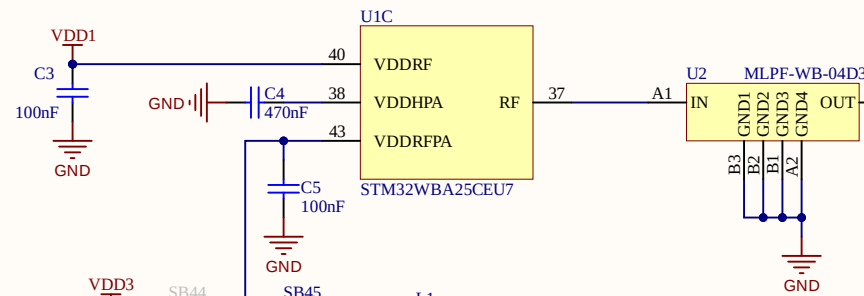
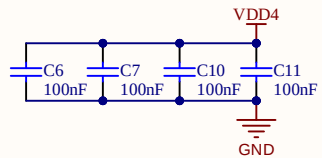
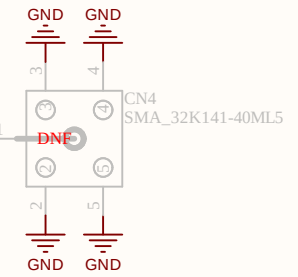
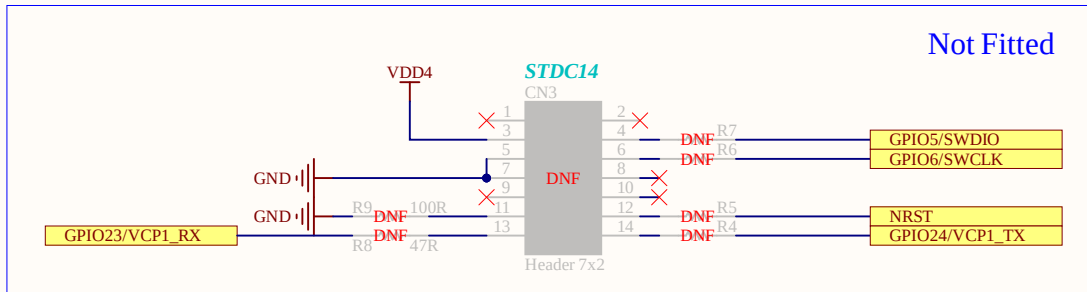


Title: Project Overview		
Project: MCU_RF_Board_WBA2_QFN48		
Variant: WBA2		
Revision: B-08		Reference: MB2293
Size: A4	Date: 05 FEB 2026	Sheet: 1 of 5

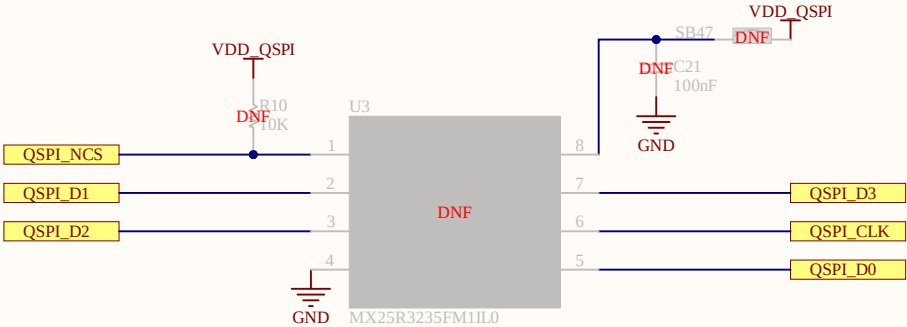


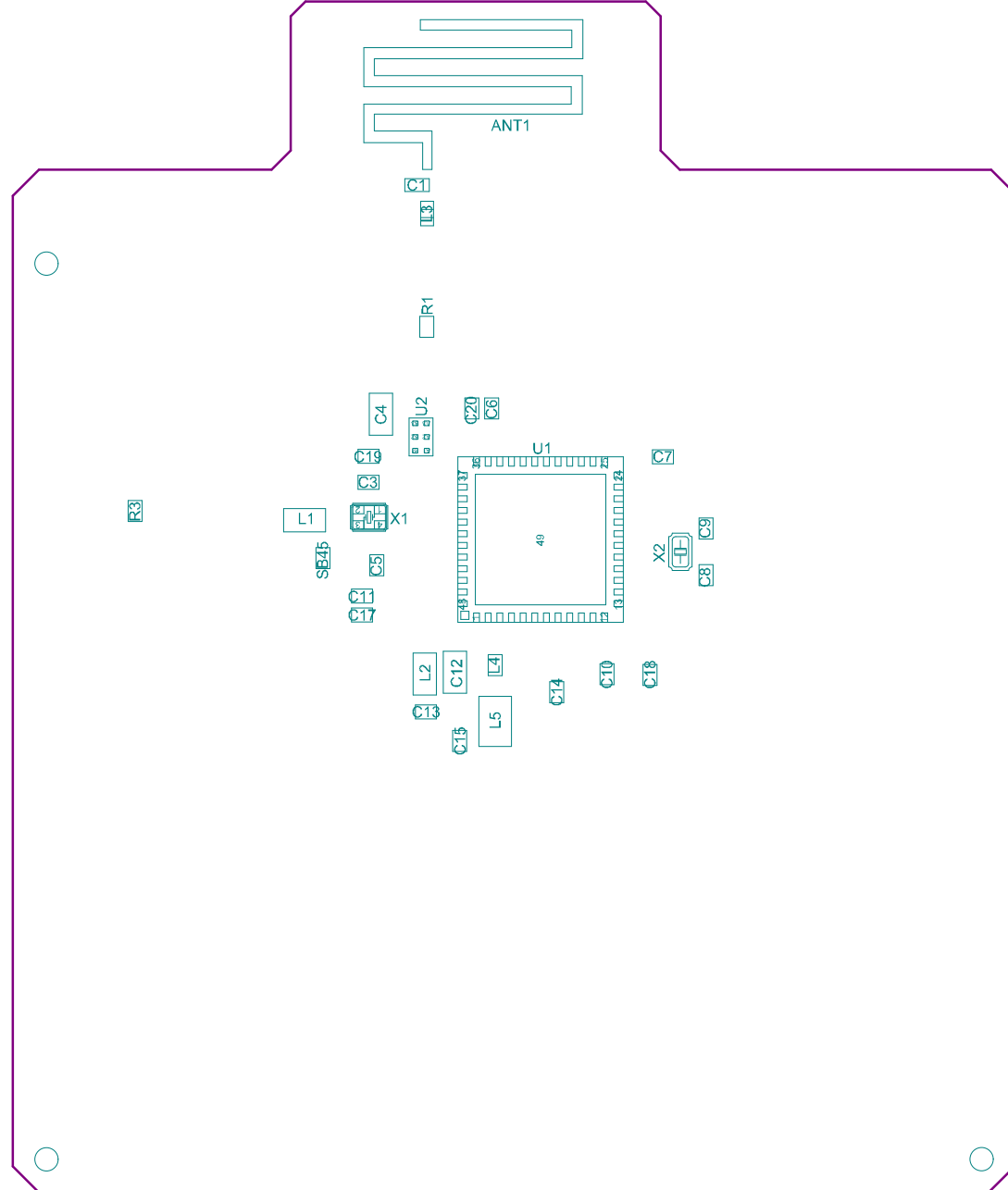




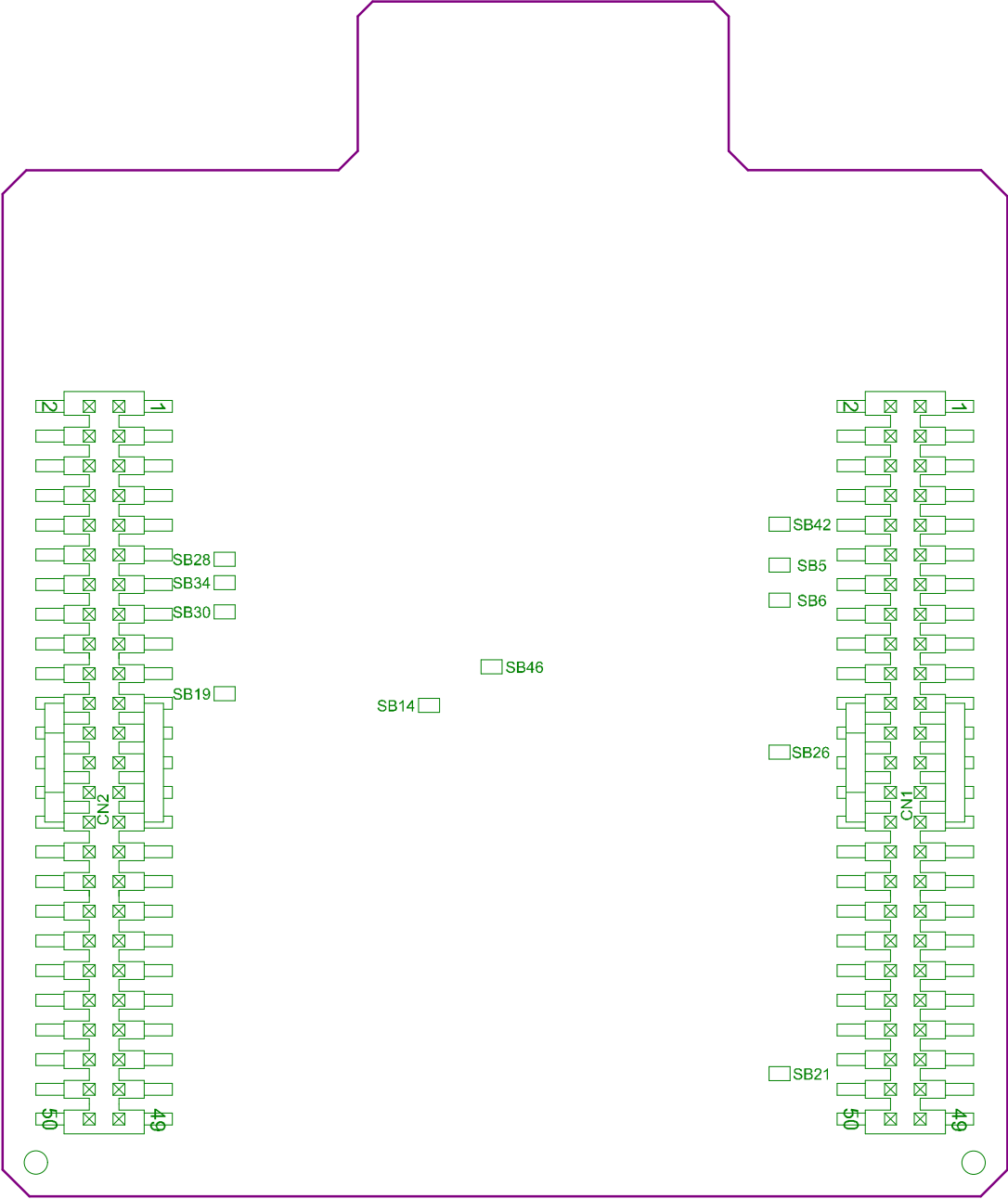


QuadSPI NOR Flash memory





Project: MCU_RF_Board_WBA2_QFN48		
Layer: M14-Top Assembly	Gerber: .GM14	
Variant: WBA2	Ref: MB2293	
Date: 05 FEB 2026	Rev: B	



Project: MCU_RF_Board_WBA2_QFN48

Layer: M15-Bottom Assembly

Variant: WBA2

Date: 05 FEB 2026

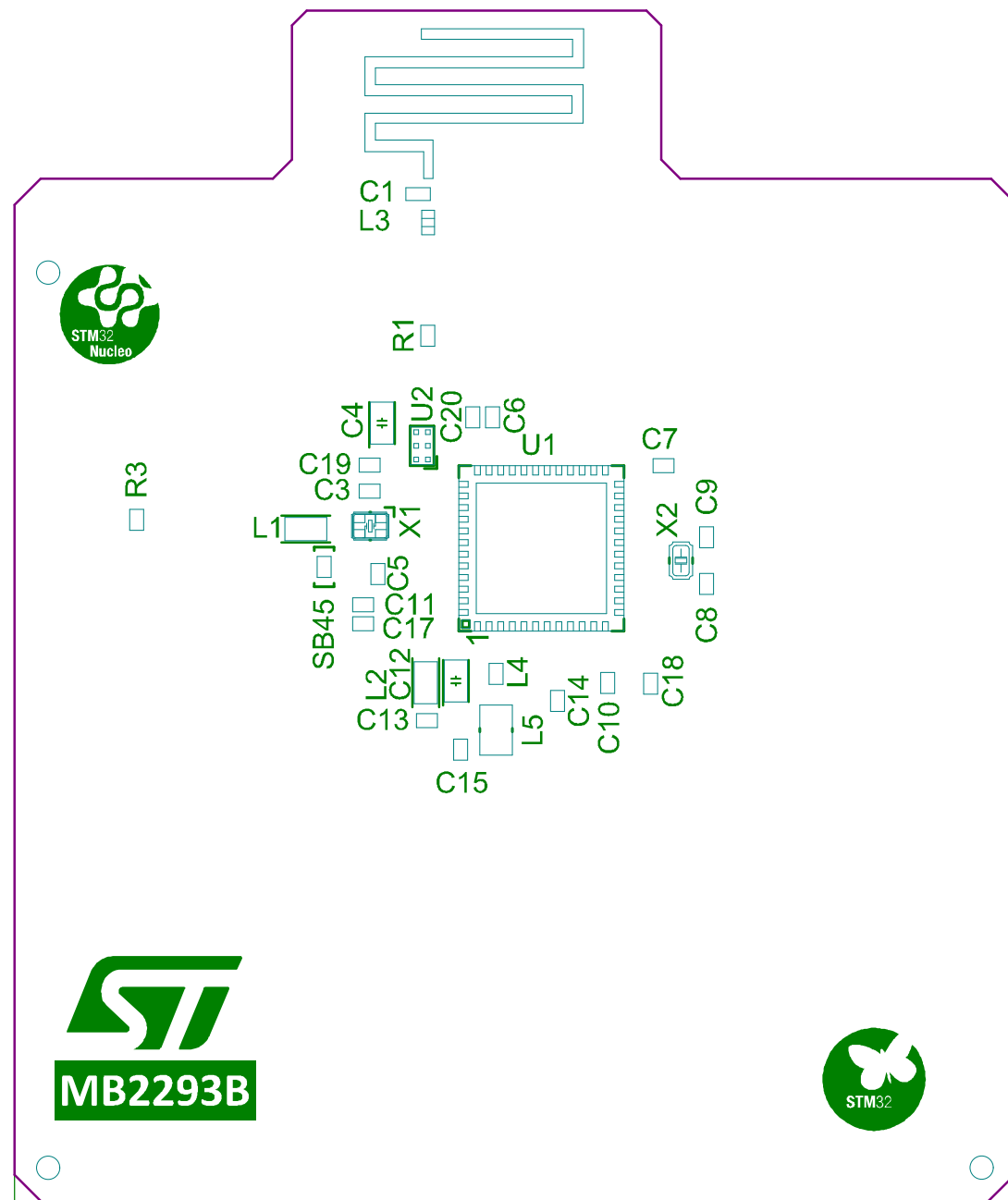
Gerber: .GM15

Ref: MB2293

Rev: B



ANT1



Top Overlay

.GTO

